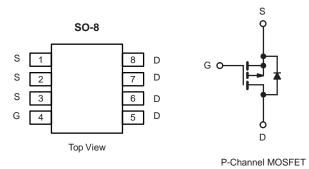


AM4407M8R-VB Datasheet P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|---------------------------------------------|--------|-----------------------|--|
| V _{DS} (V) | ν _{DS} (V) R _{DS(on)} (Ω) | | Q _g (Typ.) | |
| - 30 | 0.011 at V _{GS} = - 10 V | - 11.6 | 22 nC | |
| - 30 | 0.012 at V _{GS} = - 4.5 V | - 10 | 22110 | |



FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % Rg Tested
- 100 % UIS Tested

APPLICATIONS

- Load Switches
- Notebook PCs
 - Desktop PCs



COMPLIANT HALOGEN

FREE vailable

| Parameter | | Symbol | Limit | Uni | |
|------------------------------------------------------|------------------------|-----------------------------------|-----------------------|-----|--|
| Drain-Source Voltage | | V _{DS} | - 30 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | - 11.6 | | |
| Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$) | T _C = 70 °C | | - 10.5 | | |
| $Continuous Drain Current (1) = 150^{\circ} C)$ | T _A = 25 °C | I _D | - 8.7 ^{a, b} | | |
| | T _A = 70 °C | | - 7.7 ^{a, b} | | |
| Pulsed Drain Current | I _{DM} | - 40 | A | | |
| Orational Design Design Director Orange | T _C = 25 °C | | - 4.6 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 2.0 ^{a, b} | | |
| Avalanche Current | 1 0.4 ml l | I _{AS} | - 20 | | |
| Single-Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 20 | mJ | |
| | T _C = 25 °C | | 5.6 | | |
| Mauianua Davia Diasia atian | T _C = 70 °C | р | 3.6 | w | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{a, b} | VV | |
| | T _A = 70 °C | 1 | 1.6 ^{a, b} | | |
| Operating Junction and Storage Temperature Range | • | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---------------------------------------------|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 39 | 50 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 18 | 22 | C/VV | |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on $T_C = 25$ °C.

b. t = 10 s.

| SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted | | | | | | | |
|-------------------------------------------------------------------------------------------------------------------------------------|-------|--|--|--|--|--|--|
| Parameter Symbol Test Conditions Min. Typ. Max. U | Jnit | | | | | | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage V_{DS} $V_{GS} = 0 V$, $I_D = -250 \mu A$ -30 | V | | | | | | |
| V_{DS} Temperature Coefficient $\Delta V_{DS}/T_J$ $I_D = -250 \mu A$ -31 mV | mV/°C | | | | | | |
| $V_{GS(th)}$ lemperature Coefficient $\Delta V_{GS(th)}/I_J$ 5.5 | v/°C | | | | | | |
| | V | | | | | | |
| 666 B6 C 66 | nA | | | | | | |
| $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | μA | | | | | | |
| Zero Gate Voltage Drain CurrentIIIVVSVVSS-5 | | | | | | | |
| | А | | | | | | |
| Drain-Source On-State Resistance ^a $R_{DS(on)} = \frac{V_{GS} = -10 V_{ID} = -10 A}{V_{GS} = -10 V_{ID} = -7 A} = 0.011$ | Ω | | | | | | |
| $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7 \text{ A} \qquad 0.012$ | 52 | | | | | | |
| Forward Transconductance ^a g_{fs} $V_{DS} = -10 \text{ V}, I_D = -10 \text{ A}$ 23 | S | | | | | | |
| Dynamic ^b | | | | | | | |
| Input Capacitance C _{iss} 1960 | | | | | | | |
| | pF | | | | | | |
| Reverse Transfer Capacitance C _{rss} 325 | | | | | | | |
| Total Gate Charge Q_{g} $V_{DS} = -15 V, V_{GS} = -10 V, I_{D} = -10 A$ 43 65 | | | | | | | |
| | nC | | | | | | |
| Gate-Source Charge Q_{gs} $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$ 6 | | | | | | | |
| Gate-Drain Charge Q _{gd} 11 | | | | | | | |
| | Ω | | | | | | |
| Turn-On Delay Time t _{d(on)} 11 22 | | | | | | | |
| Rise Time t_r $V_{DD} = -15 \text{ V}, \text{ R}_L = 3 \Omega$ 13 25 | | | | | | | |
| Turn-Off DelayTime $t_{d(off)}$ $I_D \cong$ - 5 A, V_{GEN} = - 10 V, R_g = 1 Ω 3250 | | | | | | | |
| Fall Time t _f 9 18 | ns | | | | | | |
| Turn-On Delay Time t _{d(on)} 44 70 | 115 | | | | | | |
| Rise Time t_r $V_{DD} = -15 \text{ V}, \text{ R}_L = 3 \Omega$ 100 160 | | | | | | | |
| Turn-Off DelayTime $t_{d(off)}$ $I_D \cong$ - 5 A, V_{GEN} = - 4.5 V, R_g = 1 Ω 2850 | | | | | | | |
| Fall Time t _f 15 30 | | | | | | | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Continuous Source-Drain Diode CurrentIT $T_C = 25 \ ^{\circ}C$ - 4.6 | А | | | | | | |
| Pulse Diode Forward Current I _{SM} - 50 | | | | | | | |
| Body Diode Voltage V_{SD} $I_S = -2 \text{ A}, V_{GS} = 0 \text{ V}$ -0.75 -1.2 | V | | | | | | |
| | ns | | | | | | |
| Body Diode Reverse Recovery Charge Q_{rr} $I_F = -2 A$, $dI/dt = 100 A/\mu s$, $T_J = 25 °C$ 20 40 m | nC | | | | | | |
| Reverse Recovery Fail Time t _a | ns | | | | | | |
| Reverse Recovery Rise Time t _b 15 | | | | | | | |

Notes:

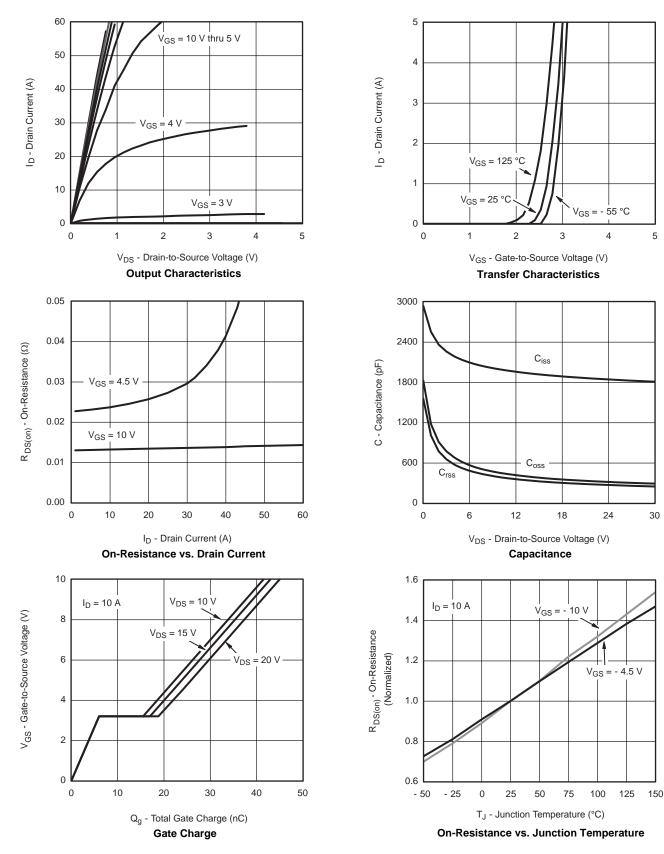
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

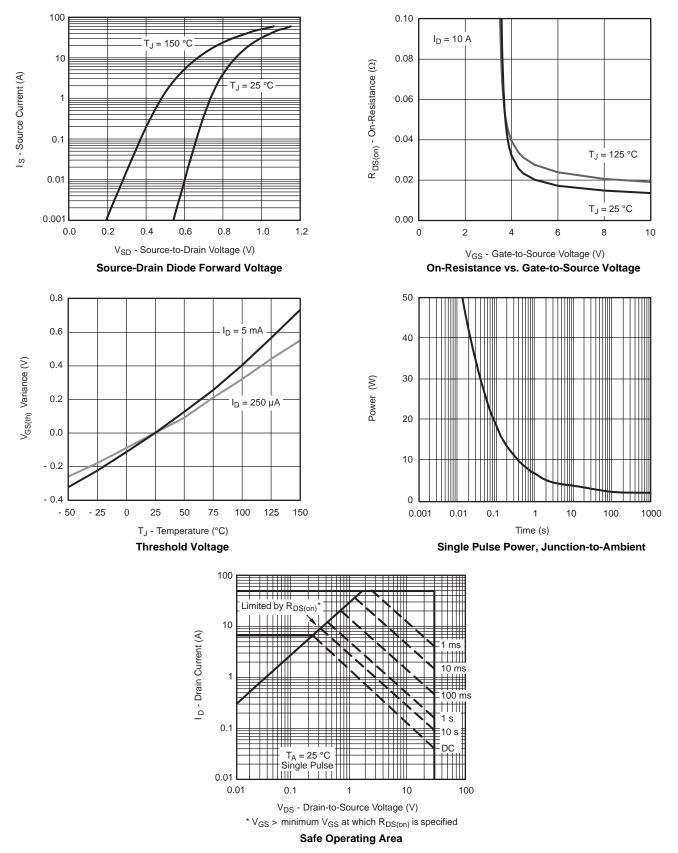
VBsemi VBsemi.com



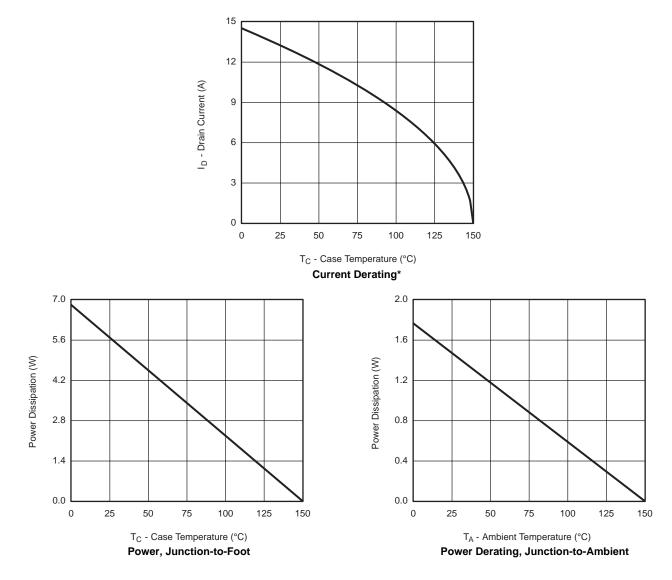


服务热线:400-655-8788



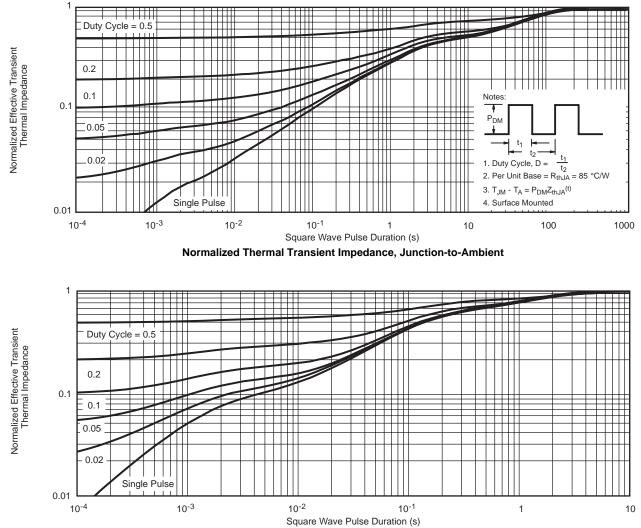






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





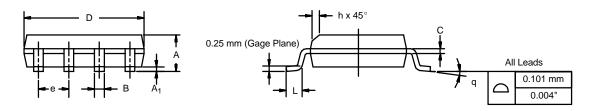
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

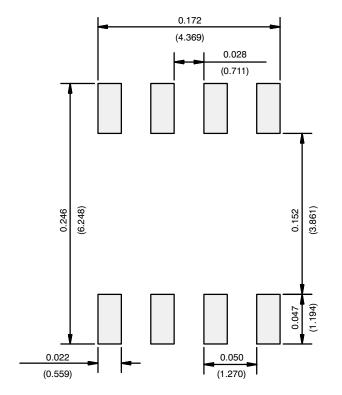




| | MILLIMETERS INCHES | | HES | | |
|---------------------------------------------|--------------------|------|-----------|-------|--|
| DIM | Min | Мах | Min | Max | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 BSC | | 0.050 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | |



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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